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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Dual precision monostable multivibrator Rev. 6 — 15 November 2011

Product data sheet

General description 1.

The HEF4938B is a dual retriggerable-resettable monostable multivibrator. Each multivibrator has an active LOW trigger/retrigger input (nA), an active HIGH trigger/retrigger input (nB), an overriding active LOW direct reset input (nCD), an output (nQ) and its complement (nQ), and two pins (CEXT, always connected to ground, and nREXT/CEXT) for connecting the external timing components CEXT and REXT. The typical pulse width variation over the specified temperature range is ± 0.2 %.

The multivibrator may be triggered by either the positive or the negative edges of the input pulse and will produce an accurate output pulse with a pulse width range of 10 μ s to infinity. The duration and accuracy of the output pulse are determined by the external timing components C_{EXT} and R_{EXT} . The output pulse width (t_W) is equal to $R_{EXT} \times C_{EXT}$. The linear design techniques in LOCMOS (Local Oxide CMOS) guarantee precise control of the output pulse width. A LOW level at nCD terminates the output pulse immediately. The trigger inputs' Schmitt trigger action makes the circuit highly tolerant of slower rise and fall times.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

2. Features and benefits

- Separate reset inputs
- Triggering from leading or trailing edge
- Tolerant of slow trigger rise and fall times
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

Ordering information 3.

Table 1. **Ordering information**

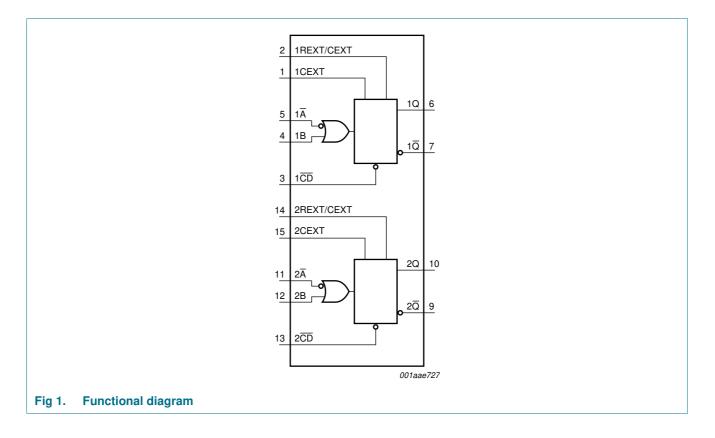
All types operate from -40 °C to +85 °C.

Type number	Package		
	Name	Description	Version
HEF4938BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4
HEF4938BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1

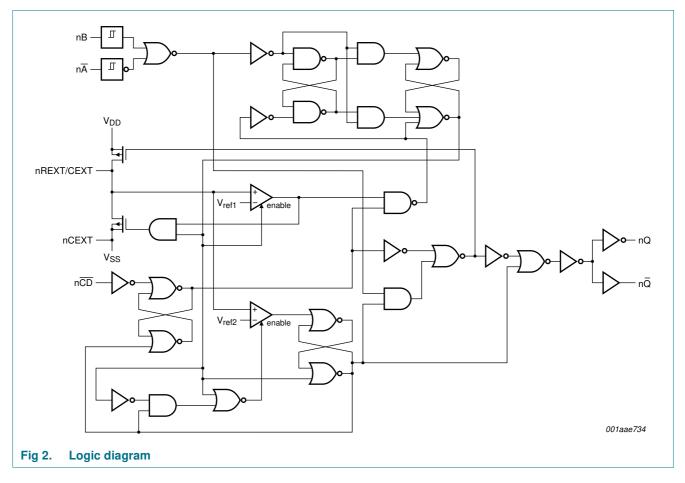


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4. Functional diagram

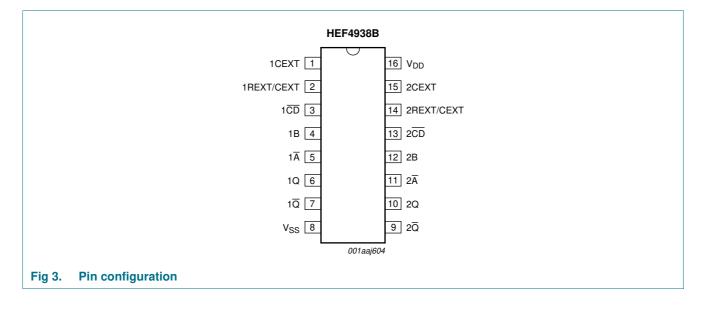


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5. Pinning information

5.1 Pinning



5.2 Pin description

1CEXT, 2CEXT 1, 15 1REXT/CEXT, 2REXT/CEXT 2, 14 1CD, 2CD 3, 13 1B, 2B 4, 12	Description
1REXT/CEXT, 2REXT/CEXT 2, 14 0 1CD, 2CD 3, 13 0 1B, 2B 4, 12 1	
1CD, 2CD 3, 13 1B, 2B 4, 12	external capacitor connection (always connected to ground)
1B, 2B 4, 12	external capacitor/resistor connection
,,,	direct reset input (active LOW)
	input (LOW-to-HIGH triggered)
1A, 2A 5, 11 i	input (HIGH-to-LOW triggered)
1Q, 2Q 6, 10	output
1 <u>Q</u> , 2 <u>Q</u> 7, 9	complementary output (active LOW)
V _{SS} 8	ground supply voltage
V _{DD} 16 s	supply voltage

6. Functional description

Table 3.	Function table ^[1]				
Inputs			Outputs		
n <mark>A</mark>	nB	nCD	nQ	nQ	
\downarrow	L	Н	Л	U	
Η	\uparrow	Н	Л	U	
Х	Х	L	L	Н	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; $\uparrow = positive-going transition$; $\downarrow = negative-going transition$;

 \square = one HIGH level output pulse, with the pulse width determined by C_{EXT} and R_{EXT};

 \Box = one LOW level output pulse, with the pulse width determined by C_{EXT} and R_{EXT}.

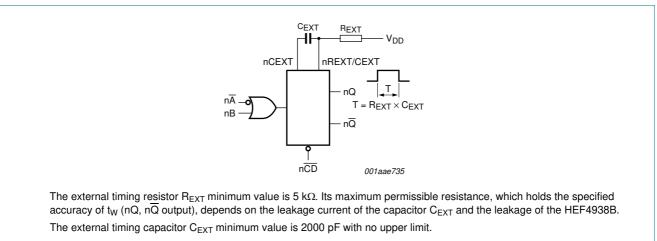
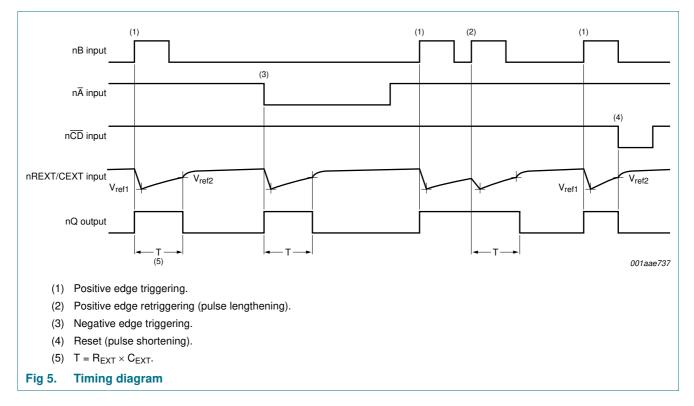


Fig 4. Connection of the external timing components R_{EXT} and C_{EXT}

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7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{SS} = 0 V$ (ground)

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_{l} < -0.5 \ V$ or $V_{l} > V_{DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	$V_{DD} + 0.5$	V
I _{OK}	output clamping current	$V_{l} < -0.5 \ V$ or $V_{l} > V_{DD}$ + 0.5 V		±10	mA
I _{I/O}	input/output current		-	±10	mA
I _{DD}	supply current			50	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+125	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +85 $^{\circ}C$			
		DIP16 package	[1] -	750	mW
		SO16 package	[2] _	500	mW
Р	power dissipation	per output	-	100	mW

[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

8. Recommended operating conditions

Table 5.	Recommended operating conditi	ons				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DD}	supply voltage		3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

9. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0$ V; $V_{I} = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	T _{amb} = -40 °C		T _{amb} = 25 °C		T _{amb} = 85 °C	
				Min	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level input voltage	I _O < 1 μA	5 V	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
VIL	LOW-level input voltage	$ I_0 < 1 \ \mu A$	5 V	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level output voltage	$ I_0 < 1 \ \mu A$	5 V	4.95	-	4.95	-	4.95	-	V
			10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V _{OL}	LOW-level output voltage	$ I_O < 1 \ \mu A$	5 V	-	0.05	-	0.05	-	0.05	V
			10 V	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level output current	$V_{O} = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	mA
		$V_{O} = 4.6 V$	5 V	-	-0.64	-	-0.5	-	-0.36	mA
		$V_{O} = 9.5 V$	10 V	-	-1.6	-	-1.3	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	mA
I _{OL} LOW-level output current	LOW-level output current	$V_{O} = 0.4 V$	5 V	0.64	-	0.5	-	0.36	-	mA
		$V_{O} = 0.5 V$	10 V	1.6	-	1.3	-	0.9	-	mA
		V _O = 1.5 V	15 V	4.2	-	3.4	-	2.4	-	mA
l _l	input leakage current	pins 2 and 14	15 V	-	±0.1	-	±0.1	-	±1.0	μA
I _{DD}	supply current	active state	5 V [<u>1]</u> -	-	(Typica	al = 55)	-	-	μA
			10 V	-	-	(Typica	l = 150)	-	-	μA
			15 V	-	-	(Typica	l = 220)	-	-	μA

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$V_{SS} = 0$ V; $V_I = V_{SS}$ or V_{DD} unless otherwise specified. Symbol Parameter Conditions T_{amb} = -40 °C T_{amb} = 25 °C T_{amb} = 85 °C Unit V_{DD} Min Max Min Max Min Max supply current $I_0 = 0 A$ 5 V 5 5 150 μA I_{DD} _ -_ 10 V 10 10 300 μA _ _ _ 15 V 20 20 600 μA --pF C_{I} input capacitance -_ -_ 7.5 _ _

Table 6. Static characteristics ... continued

[1] Only one monostable is switching: current present during output pulse (output Q is HIGH).

10. Dynamic characteristics

Table 7. **Dynamic characteristics**

V_{SS} = 0 V; T_{amb} = 25 °C; for test circuit see Figure 11; unless otherwise specified.

	, uno, -	, ·		I				
Symbol	Parameter	Conditions	V _{DD}	Extrapolation formula ^[1]	Min	Тур	Мах	Unit
t _{PHL}	HIGH to LOW	$n\overline{A}$, nB to $n\overline{Q}$;	5 V	193 ns + (0.55 ns/pF)C _L	-	220	440	ns
	propagation delay	see <u>Figure 6</u>	10 V	74 ns + (0.23 ns/pF)C _L	-	85	190	ns
			15 V	52 ns + (0.16 ns/pF)C _L	-	60	120	ns
		nCD to nQ; see Figure 6	5 V	98 ns + (0.55 ns/pF)C _L	-	125	250	ns
			10 V	44 ns + (0.23 ns/pF)C _L	-	55	110	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
t _{PLH}	LOW to HIGH	nĀ, nB to nQ;	5 V	173 ns + (0.55 ns/pF)C _L	-	200	460	ns
	propagation delay	see Figure 6	10 V	79 ns + (0.23 ns/pF)C _L	-	90	180	ns
			15 V	52 ns + (0.16 ns/pF)C _L	-	60	120	ns
		$n\overline{CD}$ to $n\overline{Q}$; see <u>Figure 6</u>	5 V	98 ns + (0.55 ns/pF)C _L	-	125	250	ns
			10 V	44 ns + (0.23 ns/pF)C _L	-	55	110	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
t _{rec}	recovery time	nCD to nA, nB; see <u>Figure 7</u>	5 V		-	20	40	ns
			10 V		-	10	20	ns
			15 V		-	5	10	ns
t _{rtrig}	retrigger time	nQ, nQ to nA, nB; see <u>Figure 7</u>	5 V		0	-	-	ns
			10 V		0	-	-	ns
			15 V		0	-	-	ns
tw	pulse width	A input LOW; minimum width; see Figure 7	5 V		90	45	-	ns
			10 V		30	15	-	ns
			15 V		24	12	-	ns
	nB input HIGH;	5 V		50	25	-	ns	
		minimum width; see Figure 7	10 V		24	12	-	ns
			15 V		20	10	-	ns
		nQ or $n\overline{Q}$ output;	5 V		9.3	10.0	10.6	ms
		R _{EXT} = 100 kΩ; C _{EXT} = 0.1 μF;	10 V		9.2	9.9	10.5	ms
		see Figure 7	15 V		9.1	9.8	10.4	ms

Product data sheet

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$V_{SS} = 0 V$; $T_{amb} = 25$ °C; for test circuit see <u>Figure 11</u>; unless otherwise specified. Symbol Parameter Conditions Extrapolation formula^[1] Min Unit V_{DD} Тур Max nQ or $n\overline{Q}$ output pulse width 5 V ±0.2 ∆tw -% _ variation variation over 10 V ±0.2 _ % _ temperature (T_{amb}) 15 V ±0.2 _ % _ range; see Figure 8 nQ or $n\overline{Q}$ output ±1.5 % _ variation over V_{DD} voltage range 5 V to 15 V; see Figure 9 nQ or $n\overline{Q}$ output 5 V ±1 % _ variation between same 10 V % _ ±1 _ package devices; 15 V % _ ±1 _ $R_{EXT} = 100 \text{ k}\Omega;$ $C_{EXT} = 2 \text{ nF to } 10 \mu \text{F}$ input capacitance nREXT/CEXT CI 15 pF _ -

Table 7. Dynamic characteristics ... continued

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

11. Waveforms

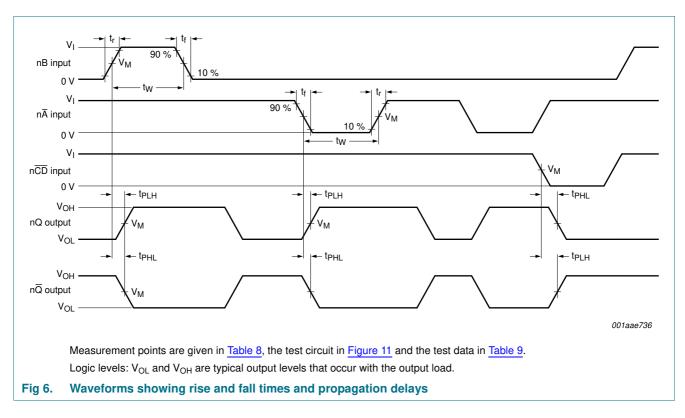


Table 8. Measurement points

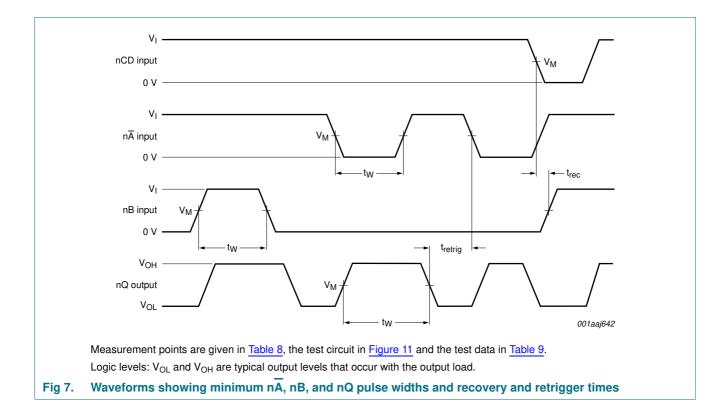
Supply voltage	Input	Output
V _{DD}	V _M	V _M
5 V to 15 V	0.5V _{DD}	0.5V _{DD}

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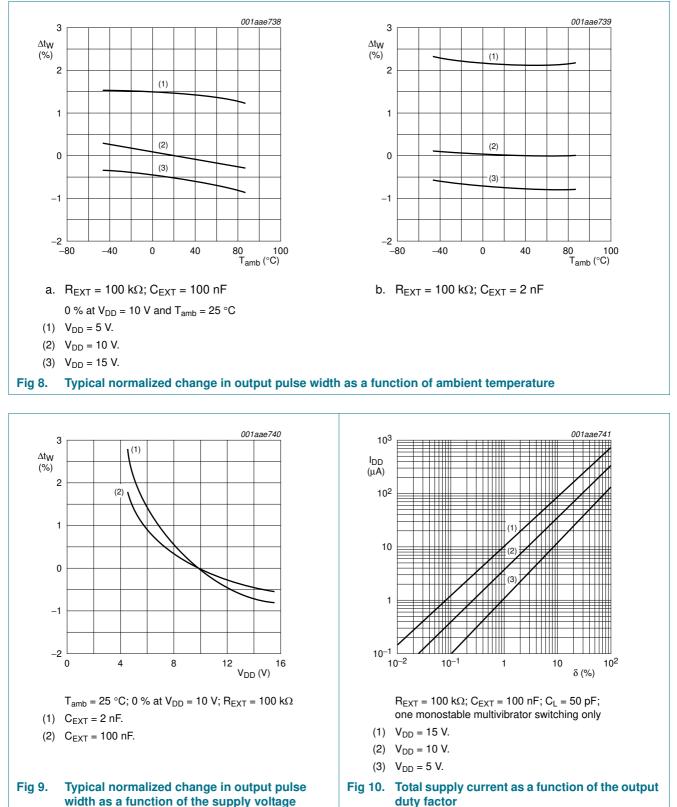


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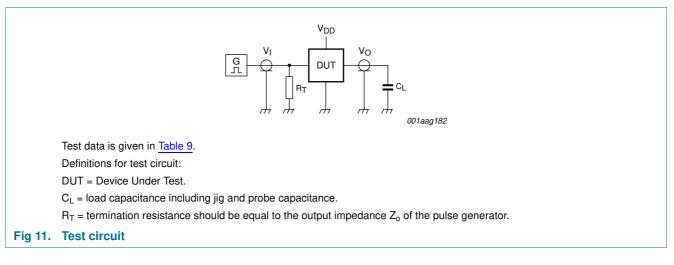


Table 9. Test data

Supply voltage	Input		Load
V _{DD}	VI	t _r , t _f	CL
5 V to 15 V	V_{SS} or V_{DD}	≤ 20 ns	50 pF

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12. Package outline

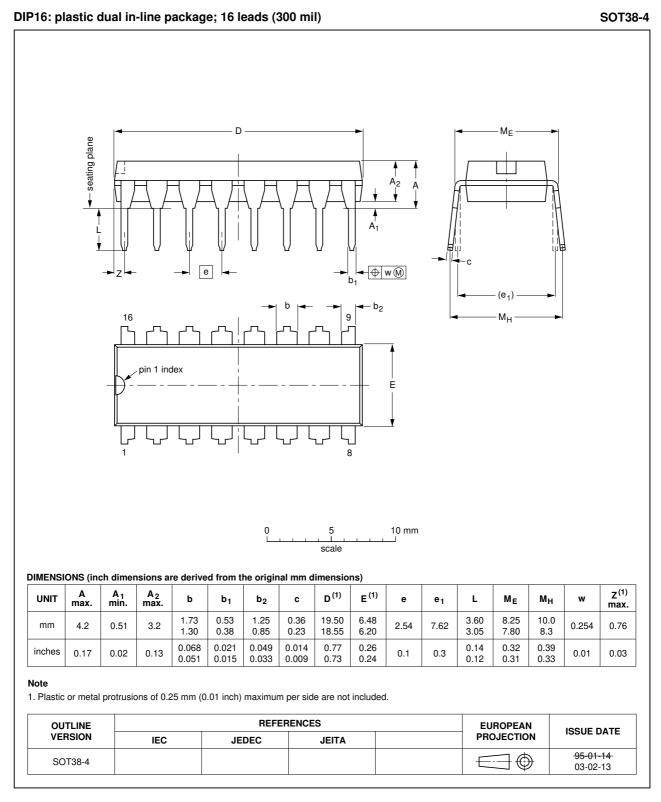


Fig 12. Package outline SOT38-4 (DIP16)

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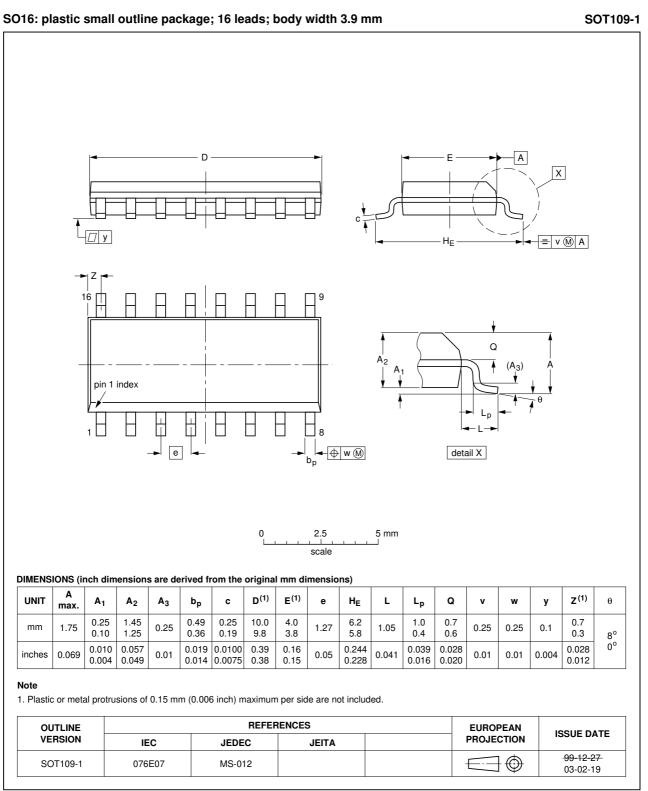


Fig 13. Package outline SOT109-1 (SO16)

HEF4938B

13. Revision history

Table 10. Revision hi	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4938B v.6	20111115	Product data sheet	-	HEF4938B v.5
Modifications:	 Section App 	blications removed		
	 <u>Table 6</u>: I_{OH} 	minimum values changed to	o maximum	
	 Figure 11: a 	dded "DUT = Device Under	Test"	
HEF4938B v.5	20100106	Product data sheet	-	HEF4938B v.4
HEF4938B v.4	20090309	Product data sheet	-	HEF4938B_CNV v.3
HEF4938B_CNV v.3	19950101	Product specification	-	HEF4938B_CNV v.2
HEF4938B_CNV v.2	19950101	Product specification	-	-

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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